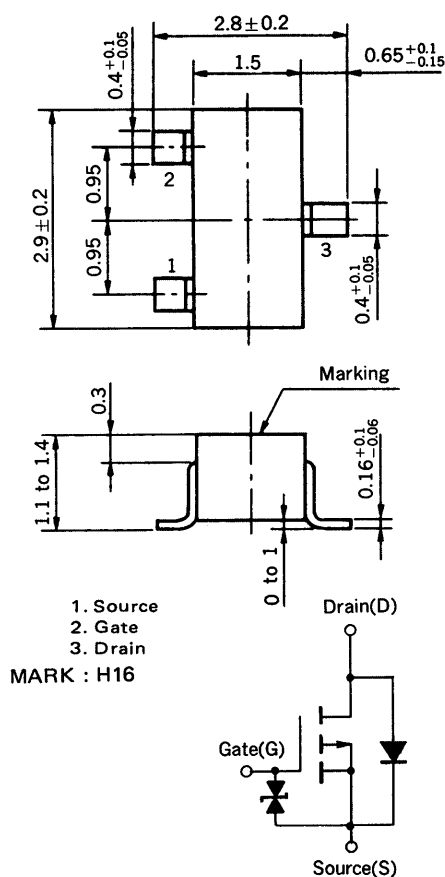


MOS FIELD EFFECT TRANSISTOR

2SJ210

P-CHANNEL MOS FET FOR SWITCHING

OUTLINE DIMENSIONS (Unit : mm)



(Diode in the figure is the parasitic diode.)

ABSOLUTE MAXIMUM RATINGS ($T_a = 25^\circ\text{C}$)

CHARACTERISTIC	SYMBOL	CONDITIONS	RATINGS	UNIT
Drain to Source Voltage	V_{DS}	$V_{GS} = 0$	-60	V
Gate to Source Voltage	V_{GS}	$V_{DS} = 0$	± 20	V
Drain Current	$I_D(\text{DC})$		± 200	mA
Drain Current	$I_D(\text{pulse})$	$PW \leq 10 \text{ ms}, \text{Duty Cycle} \leq 50 \%$	± 400	mA
Total Power Dissipation	P_T		200	mW
Channel Temperature	T_{ch}		150	$^\circ\text{C}$
Storage Temperature	T_{stg}		-55 to +150	$^\circ\text{C}$

The 2SJ210, P-channel vertical type MOS FET, is a switching device which can be driven directly by the output of ICs having a 5 V power source.

The MOS FET has excellent switching characteristics and is suitable as a high-speed switching device in digital circuits.

FEATURES

- Directly driven by the output of ICs having a 5 V power source.
- Not necessary to consider driving current because of its high input impedance.
- Possible to reduce the number of parts by omitting the bias resistor.

QUALITY GRADE

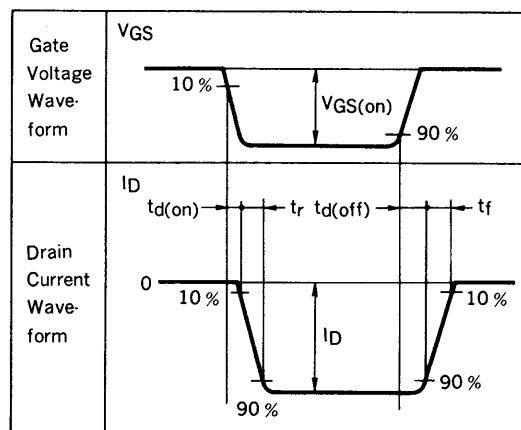
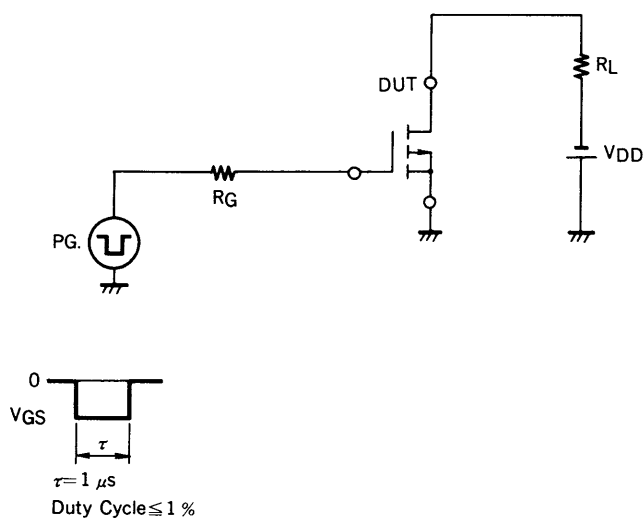
Standard

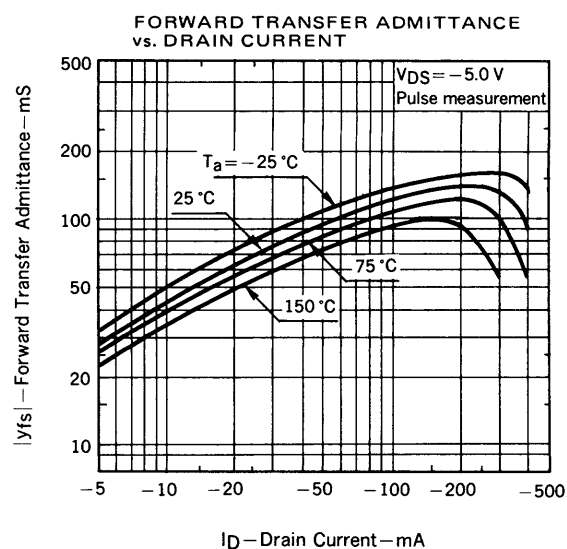
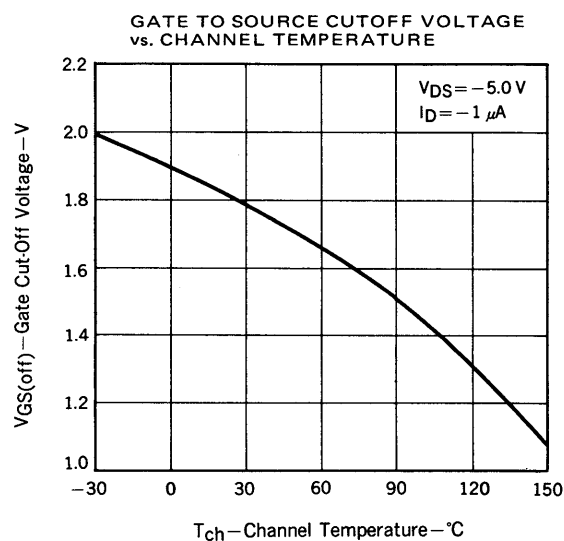
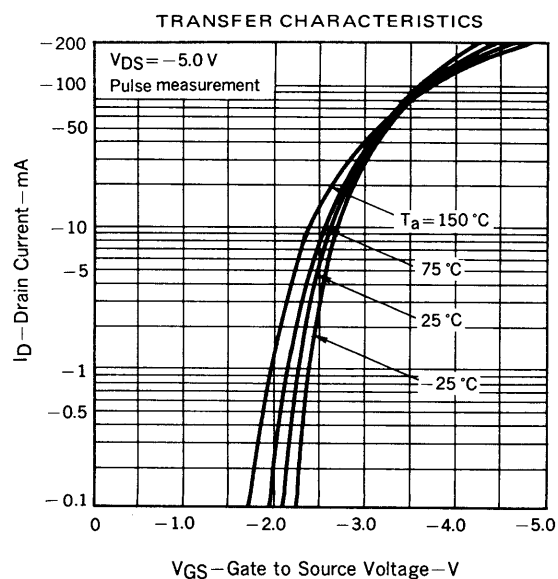
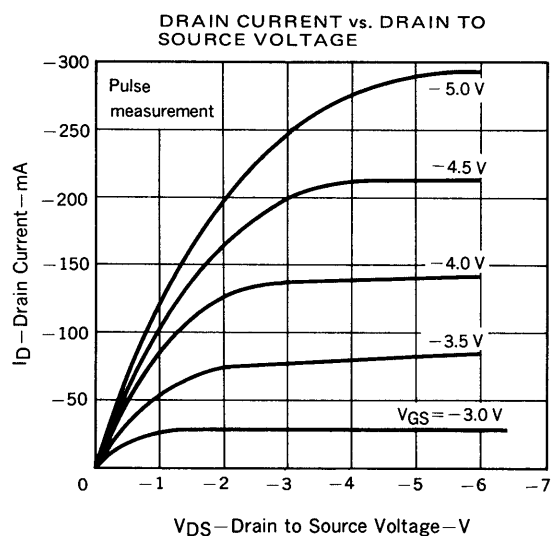
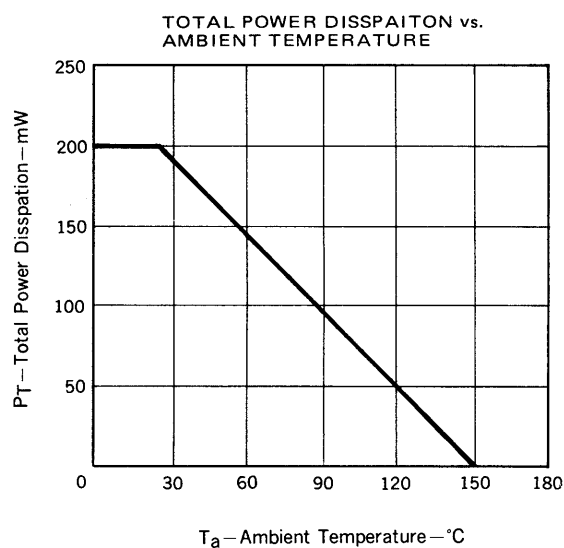
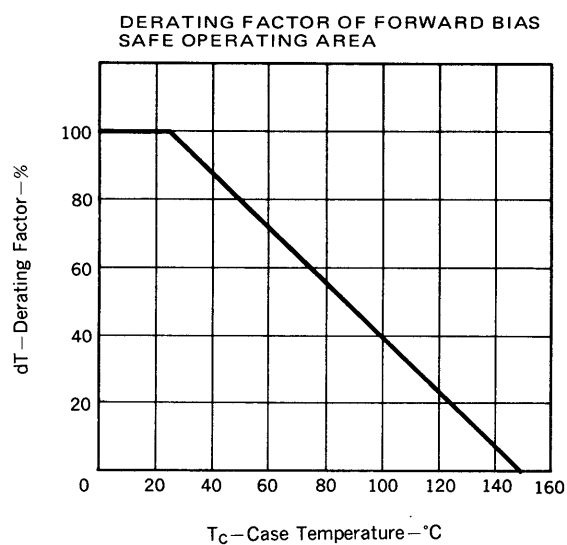
Please refer to "Quality grade on NEC Semiconductor Devices" (Document number IEI-1209) published by NEC Corporation to know the specification of quality grade on the devices and its recommended applications.

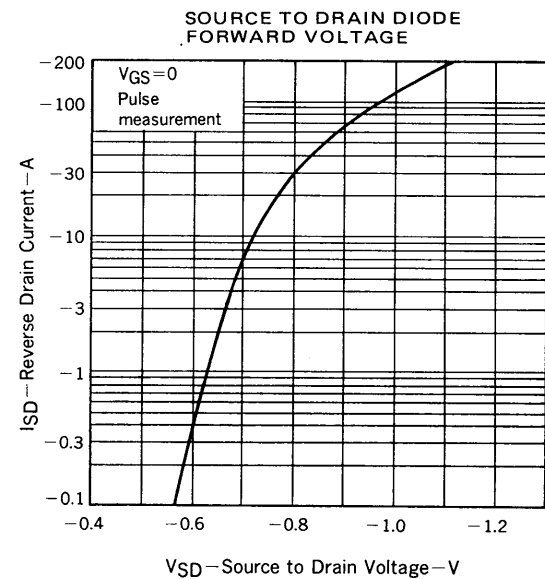
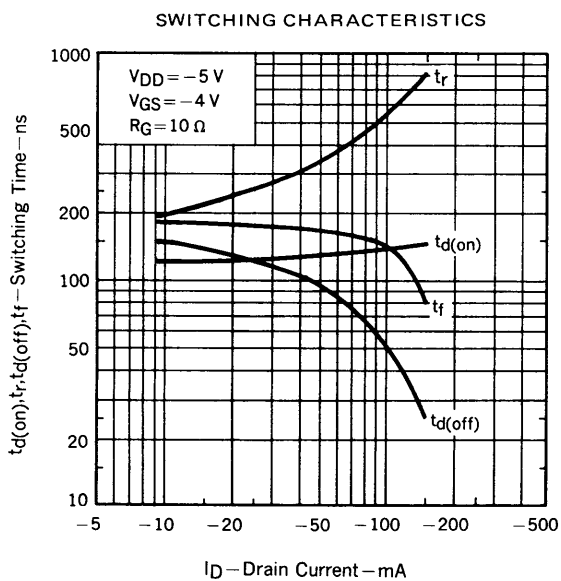
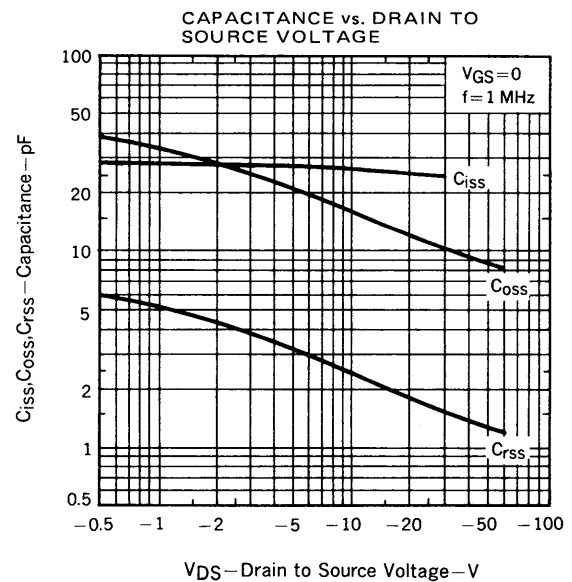
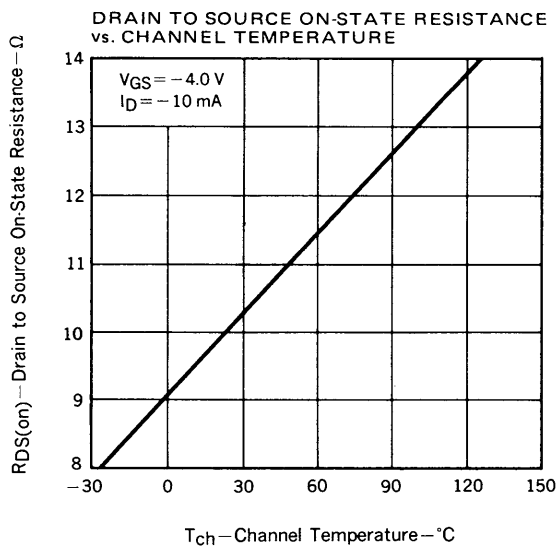
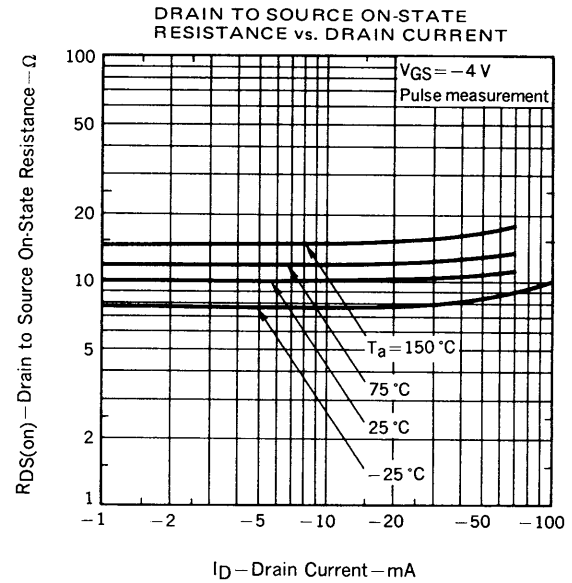
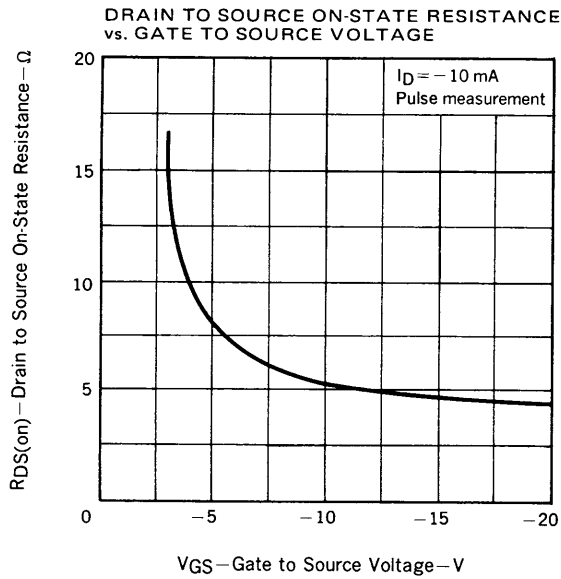
ELECTRICAL CHARACTERISTICS ($T_a = 25^\circ\text{C}$)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS
Drain Cut-off Current	I_{DSS}			-1.0	μA	$V_{DS} = -60\text{ V}, V_{GS} = 0$
Gate Leakage Current	I_{GSS}			± 1.0	μA	$V_{GS} = \pm 20\text{ V}, V_{DS} = 0$
Gate Cut-off Voltage	$V_{GS(off)}$	-1.4	-1.8	-2.4	V	$V_{DS} = -5.0\text{ V}, I_D = -1.0\text{ }\mu\text{A}$
Forward Transfer Admittance	$ y_{fs} $	20	45		mS	$V_{DS} = -5.0\text{ V}, I_D = -10\text{ mA}$
Drain to Source On-State Resistance	$R_{DS(on)1}$		10	15	Ω	$V_{GS} = -4.0\text{ V}, I_D = -10\text{ mA}$
Drain to Source On-State Resistance	$R_{DS(on)2}$		6	10	Ω	$V_{GS} = -10\text{ V}, I_D = -10\text{ mA}$
Input Capacitance	C_{iss}		27		pF	$V_{DS} = -5.0\text{ V}, V_{GS} = 0, f = 1\text{ MHz}$
Output Capacitance	C_{oss}		21		pF	
Feedback Capacitance	C_{rss}		3		pF	
Turn-On Delay Time	$t_{d(on)}$		120		ns	$V_{GS(on)} = -4.0\text{ V}, R_G = 10\text{ }\Omega$ $V_{DD} = -5.0\text{ V}, I_D = -10\text{ mA}$ $R_L = 500\text{ }\Omega$
Rise Time	t_r		190		ns	
Turn-Off Delay Time	$t_{d(off)}$		150		ns	
Fall Time	t_f		180		ns	

SWITCHING TIME MEASUREMENT CIRCUIT AND CONDITIONS



TYPICAL CHARACTERISTICS ($T_a = 25^\circ\text{C}$)



RECOMMENDED SOLDERING CONDITIONS

Mounting of this product by soldering should be done under the following conditions.

Please consult our representatives about soldering methods and conditions other than these.

SURFACE MOUNT TYPE

For details of the recommended soldering conditions, see the information document.

“Device Mounting Manual for Surface Mounting (IEI-616).”

Soldering Method	Soldering Conditions	Symbol for Recommended Conditions
Infrared Reflow	Package peak temp.: 230 °C Soldering time: within 30 sec (above 210 °C) Soldering times: 1, Days limitation: none*	IR30-00
Vapor Phase Soldering	Package peak temp.: 215 °C Soldering time: within 40 sec (above 200 °C) Soldering times: 1, Days limitation: none*	VP15-00
Wave Soldering	Soldering bath temp.: below 260 °C Soldering time: within 10 sec Soldering times: 1, Days limitation: none*	WS60-00

*: Stored days under storage conditions at 25 °C and below 65 % R.H. after the dry-pack has been opened.

Note 1 Combination of soldering methods should be avoided.

[MEMO]

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Application examples recommended by NEC Corporation

Standard: Data processing and office equipment, Communication equipment (terminal, mobile). Test and Measurement equipment, Audio and Video equipment, Other consumer products, etc.

Special: Automotive and Transportation equipment, Communication equipment (trunk line), Train and Traffic control devices, industrial robots, Burning control systems, antidisaster systems, anticrime systems etc.